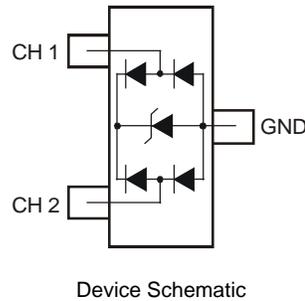


2 CHANNEL LOW CAPACITANCE TVS DIODE ARRAY
Features

- IEC 61000-4-2 (ESD): Air $\pm 15\text{kV}$, Contact $\pm 8\text{kV}$
- 2 Channels of ESD protection
- Low Channel Input Capacitance
- Typically Used at High Speed Ports such as USB 2.0, IEEE1394, Serial ATA, DVI, HDMI, PCI
- **Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. "Green" Device (Note 3)**

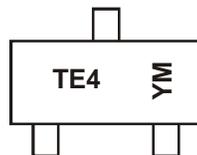
Mechanical Data

- Case: SOT23
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Matte Tin Finish annealed over Alloy 42 leadframe (Lead Free Plating). Solderable per MIL-STD-202, Method 208 **e3**
- Weight: 0.009 grams (Approximate)


Ordering Information (Note 4)

Part Number	Case	Packaging
D1213A-02SOL-7	SOT23	3,000/Tape & Reel

- Notes:
1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
 2. See <http://www.diodes.com> for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
 4. For packaging details, go to our website at <http://www.diodes.com>.

Marking Information


TE4 = Product Type Marking Code
 YM = Date Code Marking
 Y = Year (ex: Z = 2012)
 M = Month (ex: 9 = September)

Date Code Key

Year	2011	2012	2013	2014	2015	2016	2017
Code	Y	Z	A	B	C	D	E

Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	O	N	D

Maximum Ratings @T_A = 25°C unless otherwise specified

Characteristic	Symbol	Value	Unit	Conditions
Peak Pulse Current (Note 7)	I _{PP}	5	A	8/20 μs, Per Fig. 2
ESD Protection – Contact Discharge	V _{ESD Contact}	±8	kV	Standard IEC 61000-4-2
ESD Protection – Air Discharge	V _{ESD Air}	±15	kV	Standard IEC 61000-4-2

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Package Power Dissipation (Note 5)	P _D	300	mW
Thermal Resistance, Junction to Ambient (Note 5)	R _{θJA}	417	°C/W
Operating Temperature Range	T _J	-55 to +125	°C
Storage Temperature Range	T _{STG}	-65 to +150	°C

Electrical Characteristics @T_A = 25°C unless otherwise specified

Characteristic (Note 7)	Symbol	Min	Typ	Max	Unit	Test Conditions
Reverse working voltage	V _{RWM}	-	-	3.3	V	-
Reverse current (Note 6)	I _R	-	0.1	1.0	μA	V _R = V _{RWM} = 3.3V
Reverse breakdown voltage	V _{BR}	6.0	7.5	9.0	V	I _R = 1mA
Forward voltage	V _F	0.6	0.8	0.95	V	I _F = 8mA
Reverse clamping voltage, Positive Transients	V _{CL1}	-	10.0	-	V	I _{PP} = 1A, t _p = 8/20μs
Reverse clamping voltage, Negative Transients	V _{CL2}	-	-1.7	-	V	I _{PP} = -1A, t _p = 8/20μs
Dynamic resistance	R _{DYN}	-	0.9	-	Ω	I _R = 1A, t _p = 8/20μs
Capacitance	C _T	-	0.85	1.2	pF	V _R = 1.65V, f = 1MHz

- Notes:
- Device mounted on FR-4 PCB pad layout (2oz copper) as shown on Diodes, Inc. suggested pad layout AP02001, which can be found on our website at <http://www.diodes.com>.
 - Short duration pulse test used to minimize self-heating effect.
 - Measured between any channel and GND

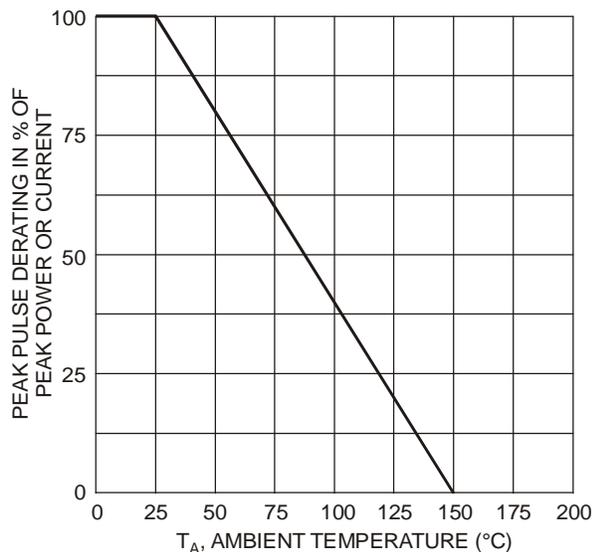


Fig. 1 Pulse Derating Curve

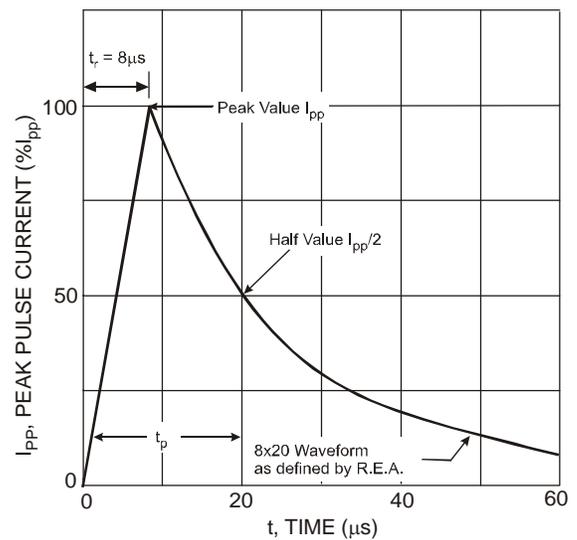
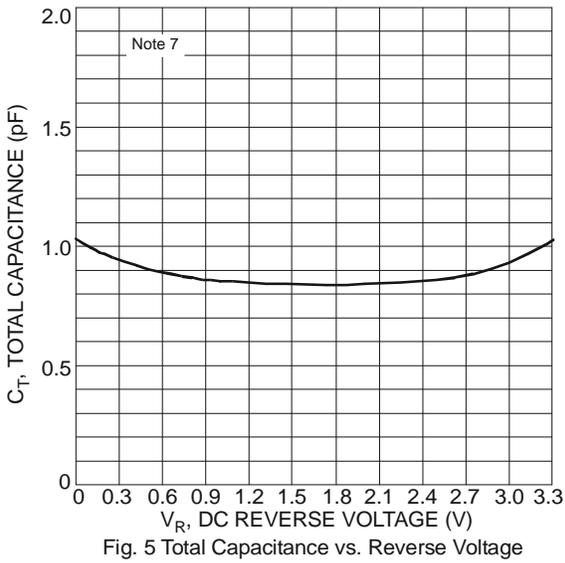
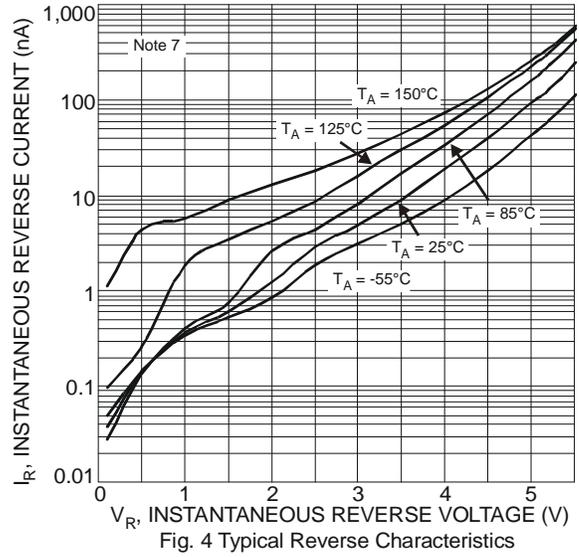
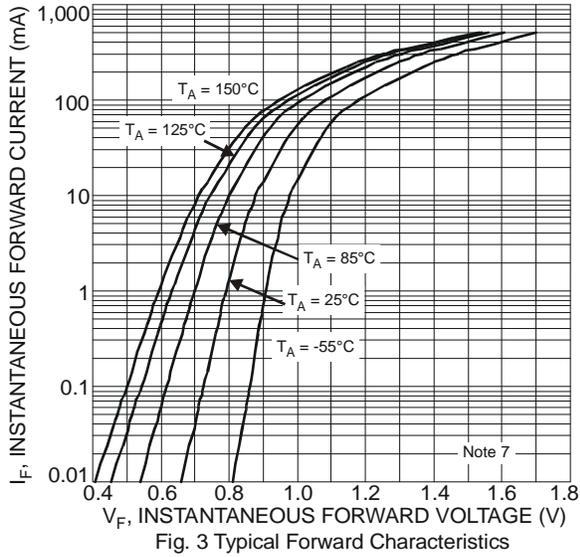
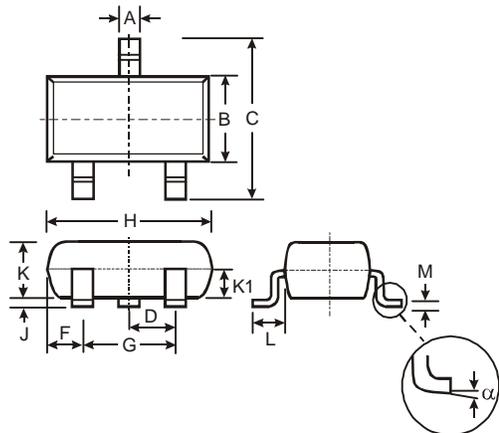


Fig. 2 Pulse Waveform



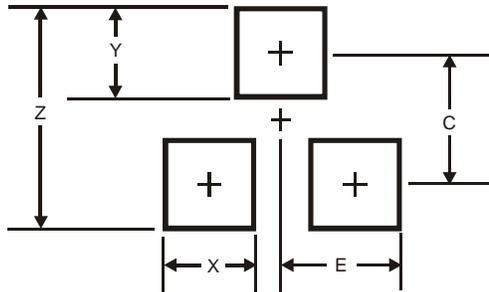
Package Outline Dimensions



SOT23			
Dim	Min	Max	Typ
A	0.37	0.51	0.40
B	1.20	1.40	1.30
C	2.30	2.50	2.40
D	0.89	1.03	0.915
F	0.45	0.60	0.535
G	1.78	2.05	1.83
H	2.80	3.00	2.90
J	0.013	0.10	0.05
K	0.903	1.10	1.00
K1	-	-	0.400
L	0.45	0.61	0.55
M	0.085	0.18	0.11
α	0°	8°	-

All Dimensions in mm

Suggested Pad Layout



Dimensions	Value (in mm)
Z	2.9
X	0.8
Y	0.9
C	2.0
E	1.35

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